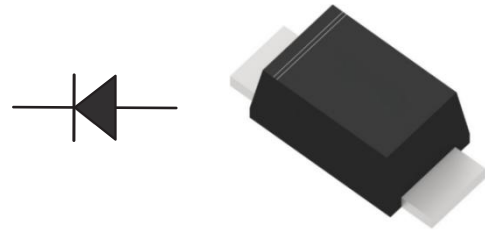


Surface Mount Superfast Recovery Rectifiers

Parameter	Value	Unit
V_{RRM}	50~600	V
$I_{F(AV)}$	1.0	A



SOD-123FL

Features

- Easy pick and place
- For surface mounted applications
- Low profile package
- Built-in strain relief
- Super fast recovery times for high efficiency

Applications

- For use in high-frequency rectification and free-wheeling applications in switching-mode converters and inverters for consumer electronics, computer systems, and telecommunications.

Absolute Maximum Ratings and Characteristics (at $T_J = 25^\circ\text{C}$ unless otherwise specified)

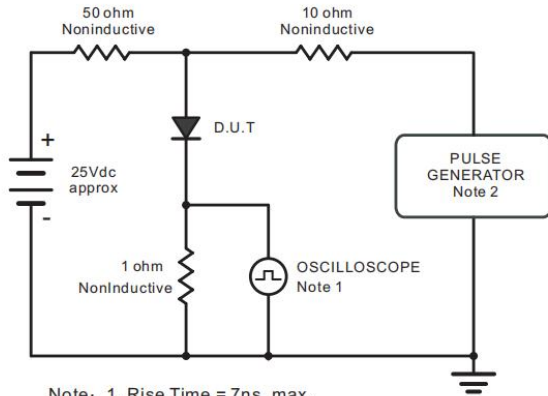
Parameter	Symbol	E1A	E1B	E1C	E1D	E1E	E1G	E1J	Units
Maximum Repetitive Peak Reverse Voltage	V_{RRM}	50	100	150	200	300	400	600	V
Maximum RMS voltage	V_{RMS}	35	70	105	140	210	280	420	V
Maximum DC Blocking Voltage	V_{DC}	50	100	150	200	300	400	600	V
Maximum Average Forward Rectified Current at $T_c = 125^\circ\text{C}$	$I_{F(AV)}$	1.0							A
Peak Forward Surge Current 8.3 ms Single Half Sine Wave Superimposed on Rated Load	I_{FSM}	30							A
Maximum Forward Voltage at 1A	V_F	1.0				1.25		1.70	V
Maximum DC Reverse Current at Rated DC Blocking Voltage	I_R					5 100			μA
Typical Junction Capacitance at $V_R=4\text{V}$, $f=1\text{MHz}$	C_j	15							pF
Maximum Reverse Recovery Time (1)	t_{rr}	35							ns
Typical Thermal Resistance (2)	$R_{\theta JA}$	85							$^\circ\text{C/W}$
Operating and Storage Temperature Range	T_j, T_{stg}	-55 ~ +150							$^\circ\text{C}$

Notes:

1. Measured with $I_F = 0.5\text{A}$, $I_R = 1\text{A}$, $I_{rr} = 0.25\text{A}$.
2. P.C. B . mounted with 0.2 X 0.2" (5 X 5 mm) copper pad areas.

Typical characteristics

Fig.1 Reverse Recovery Time Characteristic And Test Circuit Diagram



Note: 1. Rise Time = 7ns, max.
Input Impedance = 1megohm, 22pF.
2. Rise Time = 10ns, max.
Source Impedance = 50 ohms.

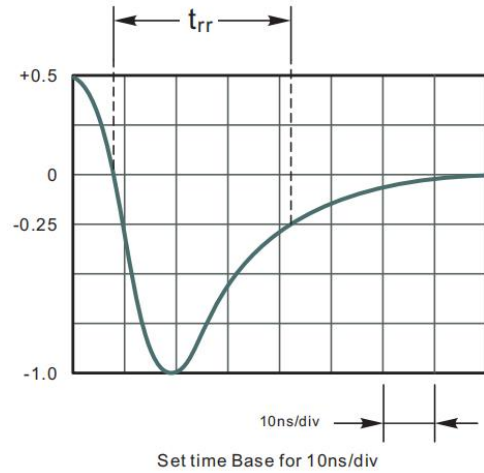


Fig.2 Maximum Average Forward Current Rating

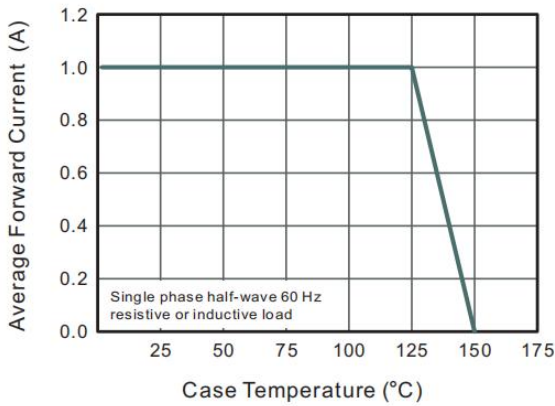


Fig.3 Typical Reverse Characteristics

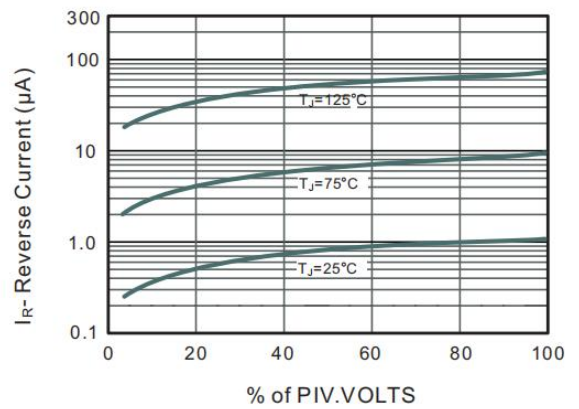


Fig.4 Typical Forward Characteristics

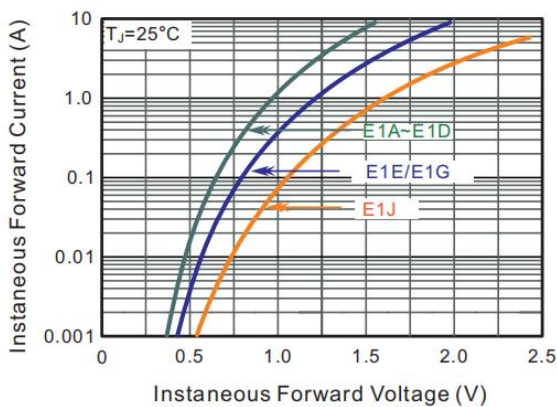


Fig.5 Typical Junction Capacitance

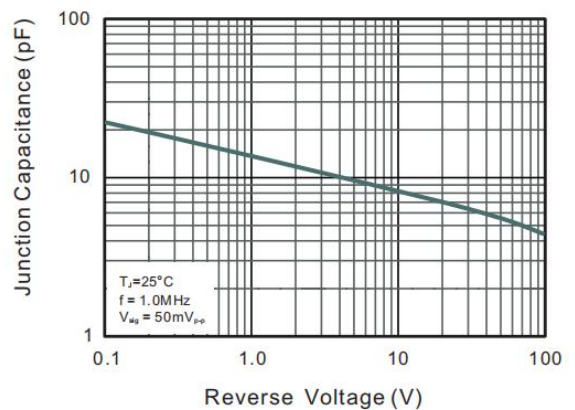
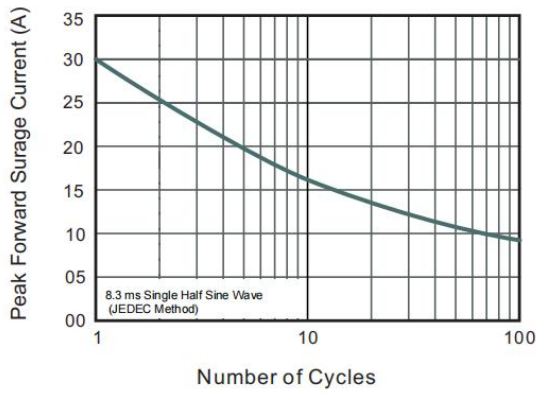
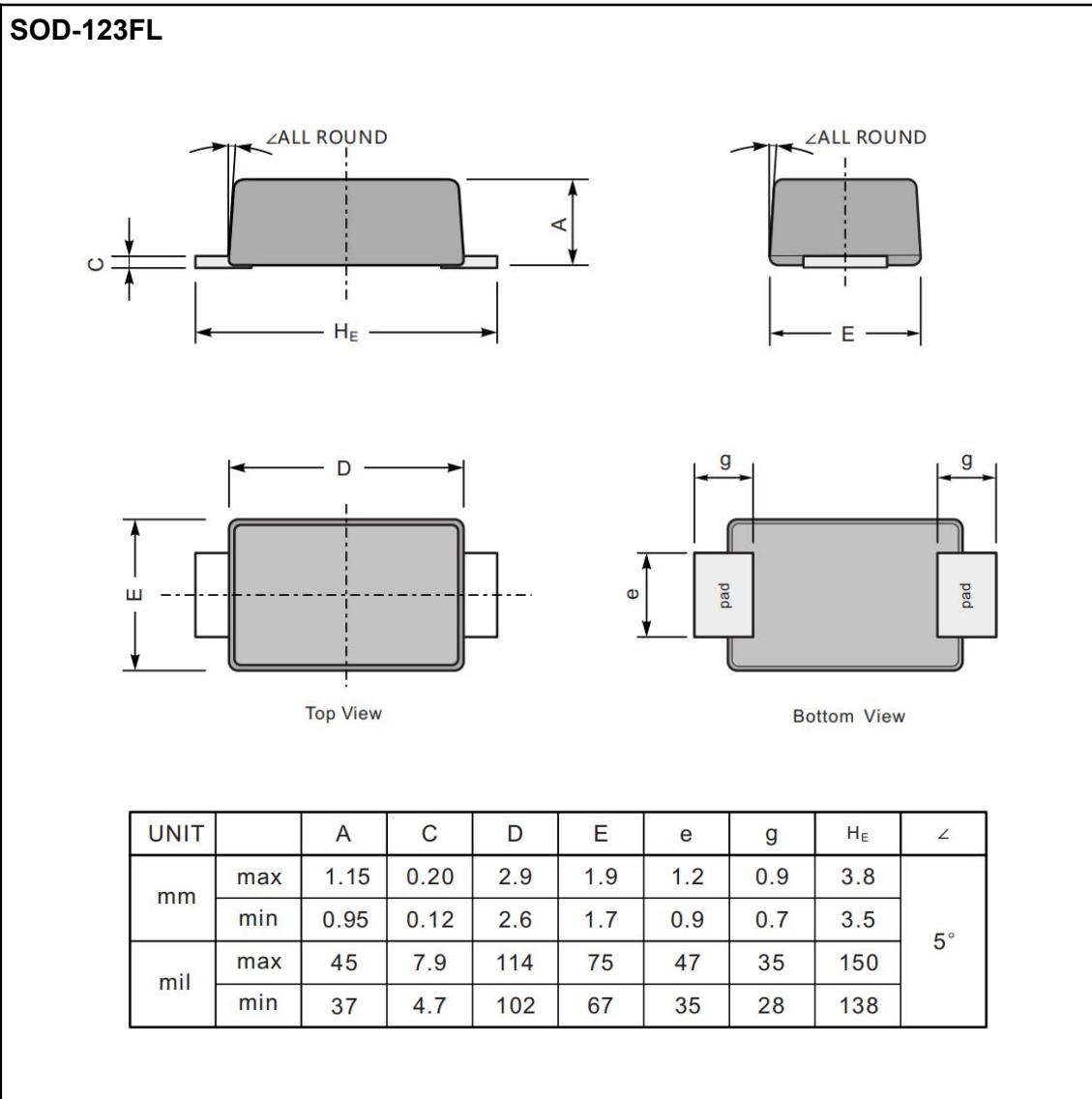


Fig.6 Maximum Non-Repetitive Peak Forward Surge Current

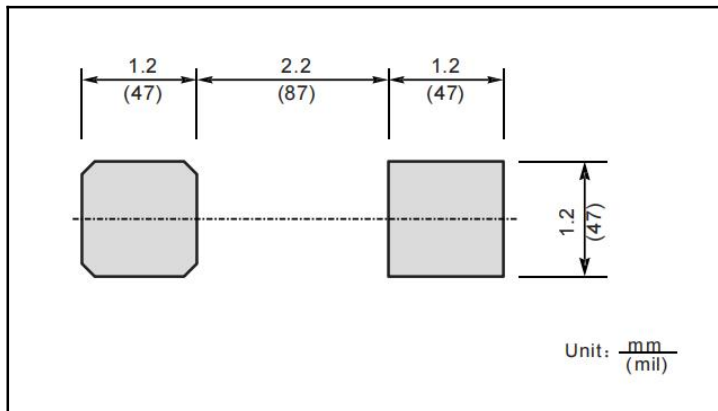


Package Outlines

Plastic surface mounted package; 2 leads



The recommended mounting pad size



Marking

Type number	Marking code
E1A	E1A
E1B	E1B
E1C	E1C
E1D	E1D
E1E	E1E
E1G	E1G
E1J	E1J

*Important Usage Information and Disclaimer

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